

# SBM1060XPC

## Surface Mount Low $V_F$ Schottky Rectifier

**Voltage**

**60 V**

**Current**

**10 A**

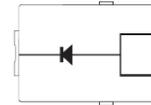
### Features

- Ideal for automated placement
- Extreme low forward voltage drop, low power loss
- High efficiency operation
- Low thermal resistance
- Ultra thin profile package for space constrained utilization
- Package suitable for automated handling
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

### Mechanical Data

- Case : TO-277C package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.11 grams

TO-277C



## Maximum Ratings and Thermal Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	60	V
Maximum RMS Voltage	$V_{RMS}$	42	V
Maximum DC Blocking Voltage	$V_{DC}$	60	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	10	A
Peak Forward Surge Current : 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	275	A
Typical Junction Capacitance Measured at 1 MHz And Applied $V_R = 4\text{ V}$	$C_J$	850	pF
Typical Thermal Resistance	(Note 1) $R_{\theta JA}$	65	$^\circ\text{C/W}$
	(Note 2) $R_{\theta JC}$	0.53	
	(Note 2) $R_{\theta JL}$	11	
Operating Junction Temperature Range	$T_J$	-55~150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55~150	$^\circ\text{C}$

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## Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Forward Voltage	$V_F$	$I_F = 1\text{ A}, T_J = 25^\circ\text{C}$	-	0.29	0.34	V
		$I_F = 5\text{ A}, T_J = 25^\circ\text{C}$	-	0.38	0.43	
		$I_F = 10\text{ A}, T_J = 25^\circ\text{C}$	-	0.44	0.49	
		$I_F = 1\text{ A}, T_J = 125^\circ\text{C}$	-	0.19	0.24	
		$I_F = 5\text{ A}, T_J = 125^\circ\text{C}$	-	0.31	0.36	
		$I_F = 10\text{ A}, T_J = 125^\circ\text{C}$	-	0.42	0.47	
Reverse current <sup>(Note 3)</sup>	$I_R$	$V_R = 42\text{ V}, T_J = 25^\circ\text{C}$	-	40	250	uA
		$V_R = 60\text{ V}, T_J = 25^\circ\text{C}$	-	66	360	
		$V_R = 60\text{ V}, T_J = 125^\circ\text{C}$	-	20	100	mA

**NOTES :**

1. Mounted on an FR4 PCB, single-sided copper, standard footprint.
2. Mounted on a FR4 PCB, single-sided copper, with 100 cm<sup>2</sup> copper pad area.
3. Short duration pulse test used to minimize self-heating effect.

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## TYPICAL CHARACTERISTIC CURVES

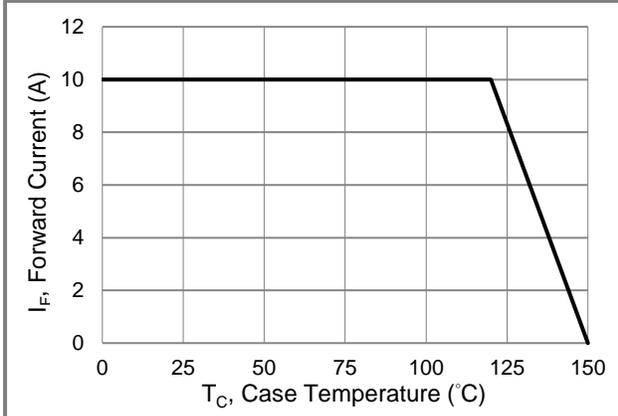


Fig.1 Forward Current Derating Curve

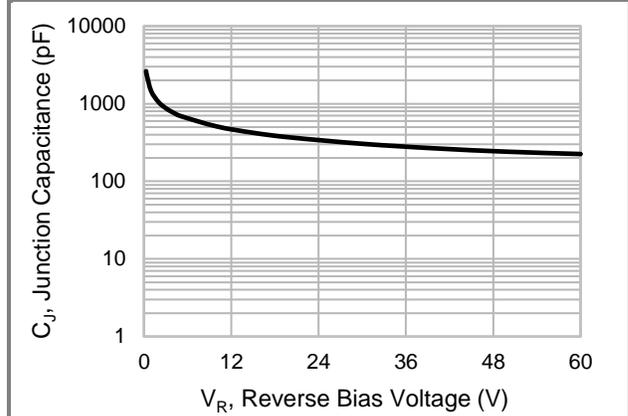


Fig.2 Typical Junction Capacitance

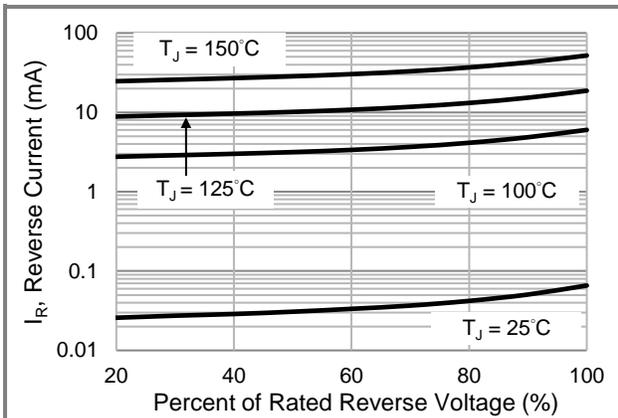


Fig.3 Typical Reverse Characteristics

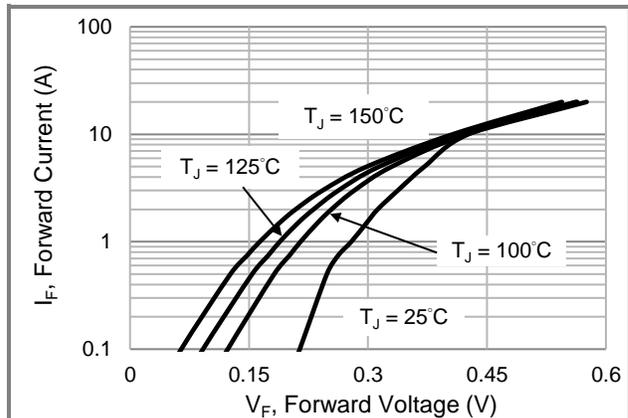


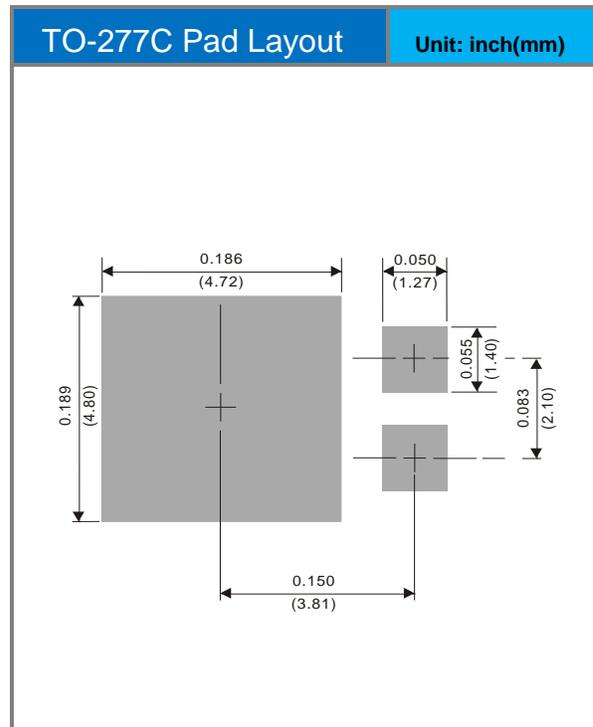
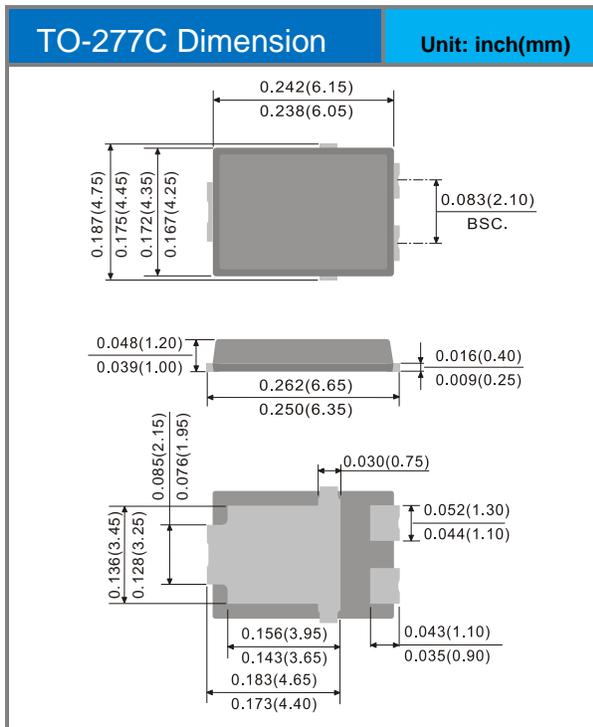
Fig.4 Typical Forward Characteristics

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## Product and Packing Information

Part No.	Package Type	Packing Type	Marking
SBM1060XPC	TO-277C	5K pcs / 13" reel	SBM1060XPC

## Packaging Information & Mounting Pad Layout



## **SBM1060XPC**

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